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U.S. PATENT & TRADEMARK OFFICE
MAR 15 2004

Docket Number (Optional)	Application Number
HITACHI [redacted]8	09/602,964
Applicant(s)	
MAZAWA, et al.	#7
Filing Date	**Group Art Unit**
June 23, 2000	2686

LB 3/24/04

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

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FOREIGN PATENT DOCUMENTS

	REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation YES	Translation NO
IQ	AA	JP10-145864	5/29/1998	Japan*abstract enclosed				✓
IQ	AB	JP10-276473	10/13/1998	Japan*abstract enclosed				✓
IQ	AC	JP10-304430	11/13/1998	Japan*abstract enclosed				✓
IQ	AD	JP10-327474	12/8/1998	Japan*abstract enclosed				✓
IQ	AE	JP10-032882	2/3/1998	Japan*abstract enclosed				✓

OTHER DOCUMENTS *(Including Author, Title, Date, Pertinent Pages, Etc.)*

EXAMINER	DATE CONSIDERED
[signature]	05/28/04

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		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES	TRANSLATION NO
ID	AF	JP11-008885	1/12/1999	Japan*abstract enclosed				✓

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